	Material Composit © Copyright 2005. IPC, 1 nternational and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a decla he declaratio	aration of on encom	f the substand npasses all lo	ces with ower lev	nin the manufactur vel materials for w	er listed it hich the m	em. Not anufact	te: if the urer has	item is an ass engineering re	embly with lowe esponsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information					
Supplier Informati	ion															
Company name*			Company unique ID			Unique ID Authority					Response Date*					
onsemi										2024-05-	2024-05-02					
Contact Name			Title - Contact			]	Phone - Contact*					Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*					Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Requester Ite	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date Version Manufacturing S		ufacturing Site	Weight*		:	UOM	Unit Type		
	MC74HC374ADTG		LOG CMOS D FLIP FLOP OCTL		2024-05-02	2		PH1	PH1		9.28		mg	Each		
Manufacturing Pro	occess Information	l						I		1				I		
Terminal Plat	Terminal Plating / Grid Array Material		erminal Base A	inal Base Alloy J-ST		L Rating	Peak P	Peak Process Body Temperatu		ature 1	ure Max Time at Peak Tem		nperature Number of Reflow Cycles		es	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		i) (no C	U Alloy 1		1		260		С		<b>30</b> seco		conds 3			
Comments												-				
evel 1 - maximum time	at peak temperature d	uring sol	dering is 10-3	0 seconds												
or more information r	egarding material com	position j	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter [F] Optionally enter the positive (+) ar				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.29	mg	Supplier	Silicon (Si)	7440-21-3		0.29	mg
Die Attach	2.46	mg	Supplier	Silver (Ag)	7440-22-4		1.845	mg
			Supplier	Epoxy resins	129915-35-1		0.615	mg
Lead Frame	38.58	mg	Supplier	Iron (Fe)	7439-89-6		0.733	mg
			Supplier	Copper (Cu)	7440-50-8		37.847	mg
Mold Compound-Black	24.35	mg		Epoxy Phenol Resin	proprietary data		2.5568	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		21.7932	mg
Plating	3.44	mg	Supplier	Palladium (Pd)	7440-05-3		0.2614	mg
			В	Nickel (Ni)	7440-02-0		3.1304	mg
			Supplier	Gold (Au)	7440-57-5		0.0482	mg
Wire Bond - Cu	0.16	mg	Supplier	Copper (Cu)	7440-50-8		0.16	mg